

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MING ZHOU	12/01/2011
RECEIVING PARTY DATA	
Name:	Semiconductor Manufacturing International (Beijing) Corporation
Street Address:	18 Wen Chang Road, Economic-Technological Development Area, Daxing District
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13316454
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ATTORNEY DOCKET NUMBER:	87720-825452 (029700US)
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Total Attachments: 1 source=87720-825452 (0297200US) EXECUTED ASSIGNMENT#page 1.tif	

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Attorney Docket No.: 87720-825452 (029700US)
Client Reference No.: IEE110154-US (2011-00207-SH-US)

ASSIGNMENT OF PATENT APPLICATION

SOLE

WHEREAS, **MING ZHOU** of 18 Wen Chang Road, Economic-Technological Development Area, Daxing District, Beijing 100176, People's Republic of China, hereinafter referred to as "Assignor," is the inventor of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention: **SEMICONDUCTOR DEVICE CAPABLE OF
REDUCING PLASMA INDUCED DAMAGE AND
FABRICATION METHOD THEREOF**

Date(s) of execution of Declaration:

Filing Date:

Application No.: ; and

WHEREAS, **SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION**, a corporation of People's Republic of China, located at 18 Wen Chang Road, Economic-Technological Development Area, Daxing District, Beijing 100176 People's Republic of China, hereinafter referred to as "ASSIGNEE," is desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has assigned, and by these presents does assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on any patent application claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees that Assignor will, without charge to Assignor, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignor hereby authorizes and requests Kilpatrick Townsend & Stockton LLP, Two Embarcadero Center, Eighth Floor, San Francisco, CA 94111-3834, to insert herein above the application number and filing date of said application when known.

IN TESTIMONY WHEREOF, Assignor has signed his/her name on the date indicated.

Dated: 2011-12-01

MING ZHOU
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